PACVGA105

VGA Port Companion Circuit

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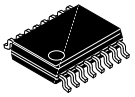


QSOP16
QR SUFFIX
CASE 492

MARKING DIAGRAM

PACVGA105QR = Specific Device Code
YY = Year
WW = Work Week
G = Pb−Free Package

ORDERING INFORMATION

Device	Package	Shipping†
PACVGA105QR	QSOP16 (Pb−Free)	2500/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Product Description

The PACVGA105 incorporates 7 channels of ESD protection for signal lines commonly found in a VGA port for PCs. ESD protection is implemented with current steering diodes designed to safely handle the high peak surge currents associated with the IEC−1000−4−2 Level−4 ESD Protection Standard (±8 kV contact discharge). When the channels are subjected to an electrostatic discharge, the ESD current pulse is diverted via the protection diodes into the positive supply rails or ground where they may be safely dissipated.

The upper ESD diodes for the R, G and B channels are connected to a separate supply rail (V_{RGB}) to facilitate interfacing to graphics controller ICs with low voltage supplies. The remaining channels are connected to the main 5 V rail (V_{CC}). The lower diodes for the R, G and B channels are also connected to a dedicated ground pin (GNDA) to minimize crosstalk due to common ground impedance.

Two non−inverting buffers are also included in this IC for buffering the HSYNC and VSYNC signals from the graphics controller IC. These buffers will accept TTL input levels and convert them to CMOS output levels that swing between GND and V_{CC}. These drivers have a nominal 60 Ω output impedance to match the characteristic impedance of the HSYNC and VSYNC lines of the video cables typically used. The inputs of these drivers also have high impedance pull−ups (50 kΩ nom.) pulling up to the V_{AUX} rail. In addition, the DDC_CLOCK and DDC_DATA channels have 1.8 kΩ resistors pulling these inputs up to the main 5 V (V_{CC}) rail.

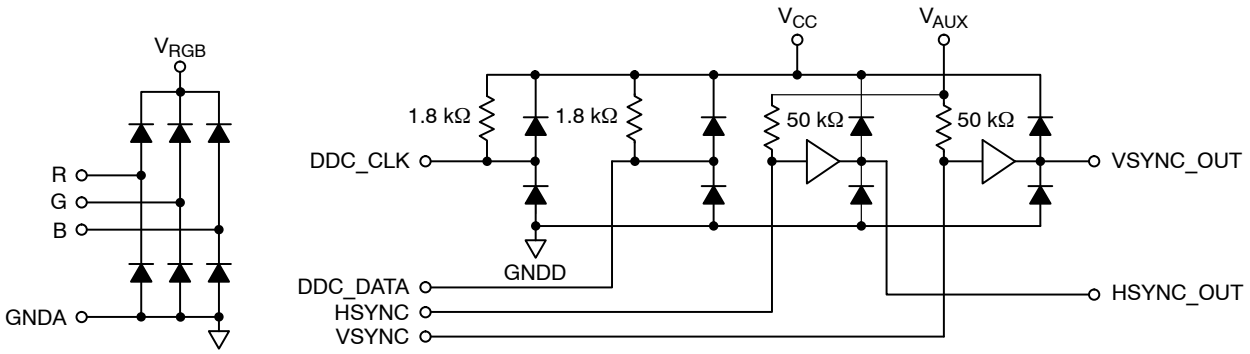
Features

- Seven Channels of ESD Protection Designed to Meet IEC−1000−4−2 Level−4 ESD Requirements (±8 kV Contact Discharge)
- Very Low Loading Capacitance from ESD Protection Diodes at Less than 5 pF Typical
- TTL to CMOS Level−Translating Buffers for the HSYNC and VSYNC Lines
- Three Independent Supply Pins (V_{CC}, V_{RGB} and V_{AUX}) to Facilitate Operation with Sub−Micron Graphics Controller ICs
- High impedance Pull−Ups (50 kΩ Nominal to V_{AUX}) for HSYNC and VSYNC Inputs
- Pull−Up Resistors (1.8 kΩ Nominal to V_{CC}) for DDC_CLK and DDC_DATA Lines
- Compact 16−Pin QSOP Package
- These Devices are Pb−Free and are RoHS Compliant

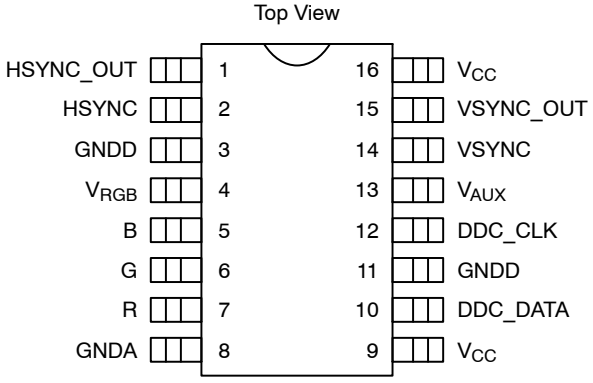
Applications

- ESD Protection and Termination Resistors for VGA (Video) Port Interfaces
- Desktop PCs
- Notebook Computers
- LCD Monitors

SIMPLIFIED ELECTRICAL SCHEMATIC



PACKAGE / PINOUT DIAGRAMS



16−Pin QSOP

Table 1. PIN DESCRIPTIONS

Lead(s)	Name	Description
1	HSYNC_OUT	Horizontal sync signal buffer output. Connects to the video connector side of the horizontal sync line.
2	HSYNC	Horizontal sync signal buffer input. Connects to the VGA Controller side of the horizontal sync line.
3, 11	GNDD	Digital ground reference supply pin.
4	V_{RGB}	V_{RGB} supply pin. This is an isolated supply pin for the R, G and B ESD protection circuits.
5	B	Blue signal video protection channel. This pin is typically tied to the B video line between the VGA controller device and the video connector.
6	G	Green signal video protection channel. This pin is typically tied to the G video line between the VGA controller device and the video connector.
7	R	Red signal video protection channel. This pin is typically tied to the R video line between the VGA controller device and the video connector.
8	GNDA	Analog ground reference supply pin.
9, 16	V_{CC}	V_{CC} supply pin. This is the main supply input for the DDC_CLK and DDC_DATA pullup resistors and ESD protection circuits. It is also connected to the sync buffers and to the ESD protection diodes present on the HSYNC_OUT and VSYNC_OUT lines.
10	DDC_DATA	DDC data pin.
12	DDC_CLK	DDC clock pin.
13	V_{AUX}	V_{AUX} supply pin. This is the supply input for the 50 kΩ pullups connected to the HSYNC and VSYNC buffer inputs.
14	VSYNC	Vertical sync signal buffer input. Connects to the VGA Controller side of the vertical sync line.
15	VSYNC_OUT	Vertical sync signal buffer output. Connects to the video connector side of the vertical sync line.

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
V_{CC}, V_{RGB}, V_{AUX} Supply Voltage Inputs	[GND − 0.5] to +6.0	V
Diode Forward Current (One Diode Conducting at a Time)	20	mA
DC Voltage at Inputs R, G, B HSYNC, VSYNC DDC_CLK, DDC_DATA	 [GND − 0.5] to [V_{RGB} + 0.5] [GND − 0.5] to [V_{AUX} + 0.5] [GND − 0.5] to [V_{CC} + 0.5]	V
Operating Temperature Range	0 to +70	°C
Storage Temperature Range	−40 to +150	°C
Package Power Rating	750	mW

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Units
V_{CC}	Main Supply Voltage	4.5	5.5	V
V_{RGB}	RGB Supply Voltage	1.7	3.7	V
V_{AUX}	Auxiliary Supply Voltage	2.9	3.7	V
V_{IH}	Logic High Input Voltage (Note 1)	2.0		V
V_{IL}	Logic Low Input Voltage (Note 1)		0.8	V
V_I	Input Voltage RGB HSYNC, VSYNC DDC_CLK, DDC_DATA	 0 0 0	 V_{RGB} V_{AUX} V_{CC}	V
I_{OH}	High Level Output Current (Note 1)		−8	mA
I_{OL}	Low Level Output Current (Note 1)		8	mA
T_A	Free−Air Operating Temperature	0	+70	°C

1. These parameters apply only to the HSYNC and VSYNC signals.

SPECIFICATIONS (Cont'd)

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_F	Diode Forward Voltage	I_F = 10 mA			1.0	V
V_{OH}	Logic High Output Voltage	I_{OH} = −4 mA, V_{CC} = 4.5 V	4.0			V
V_{OL}	Logic Low Output Voltage	I_{OL} = 4 mA, V_{CC} = 4.5 V			0.4	V
I_{IN}	Input Current R, G and B Pins HSYNC, VSYNC Pins HSYNC, VSYNC Pins	 V_{RGB} = 3.63 V, V_{IN} = V_{RGB} or GND V_{AUX} = 3.63 V, V_{IN} = V_{AUX} V_{AUX} = 3.63 V, V_{IN} = GND	 −30.0	 −72.5	 ±1 ±1 −95.0	μA
I_{CC}	V_{CC} Supply Current	V_{CC} = 5.5 V, V_{AUX} = V_{RGB} = 2.97 V, All Inputs and Outputs Floating		35	100	μA
I_{RGB}	V_{RGB} Supply Current	R, G and B Pins at V_{CC} or GND, All Inputs and Outputs Floating			10	μA
C_{IN}	Input Capacitance R, G and B pins HSYNC, VSYNC pins DDC_DATA, DDC_CLK pins	Note 2 Applies for All Cases		 5 10 5		pF
R_{PU}	Pull−up Resistance DDC_DATA, DDC_CLK pins		 1.62	 1.80	 1.98	 kΩ
V_{ESD}	ESD Withstand Voltage	V_{CC} = 5 V, V_{RGB} = 3.3 V, V_{AUX} = 3.3 V (Note 3)	±8			kV
t_{PLH}	SYNC Buffer L ≥ H Propagation Delay	C_L = 50 pF, V_{CC} = 5.0 V, R_L = 500 Ω (Note 4)		7.0	15.0	ns
t_{PHL}	SYNC Buffer H ≥ L Propagation Delay	C_L = 50 pF, V_{CC} = 5.0 V, R_L = 500 Ω (Note 4)		7.0	15.0	ns
t_R, t_F	SYNC Buffer Output Rise & Fall Times	C_L = 50 pF, V_{CC} = 5.0 V, R_L = 500 Ω (Note 4)		7.0		ns

1. All parameters specified over standard operating conditions unless otherwise noted.
2. Measured at 1 MHz. R/G/B inputs biased at 1.65 V with V_{RGB} = 3.3 V. DDC_CLK and DDC_DATA biased at 2.5 V with V_{CC} = 5 V. HSYNC and VSYNC inputs biased at V_{AUX} or GND with V_{AUX} = 3.3 V and V_{CC} = 5 V.
3. Per the IEC−61000−4−2 International ESD Standard, Level 4 contact discharge method. V_{RGB} and V_{CC} must be bypassed to GND via a low impedance ground plane with a 0.2 μF, low inductance, chip ceramic capacitor at each supply pin. ESD pulse is applied between the applicable pins and GND. ESD pulse can be positive or negative with respect to GND. Applicable pins are: R, G, B, HSYNC_OUT, VSYNC_OUT, DDC_CLK and DDC_DATA. The HSYNC and VSYNC inputs are ESD protected to the industry standard 2 kV per the Human Body Model (MIL−STD−883, Method 3015).
4. Applicable to the SYNC buffers only. Input signals swing between 0 V and 3.0 V, with rise and fall times ≤ 5 ns. Guaranteed by correlation to buffer output drive currents.

APPLICATION INFORMATION

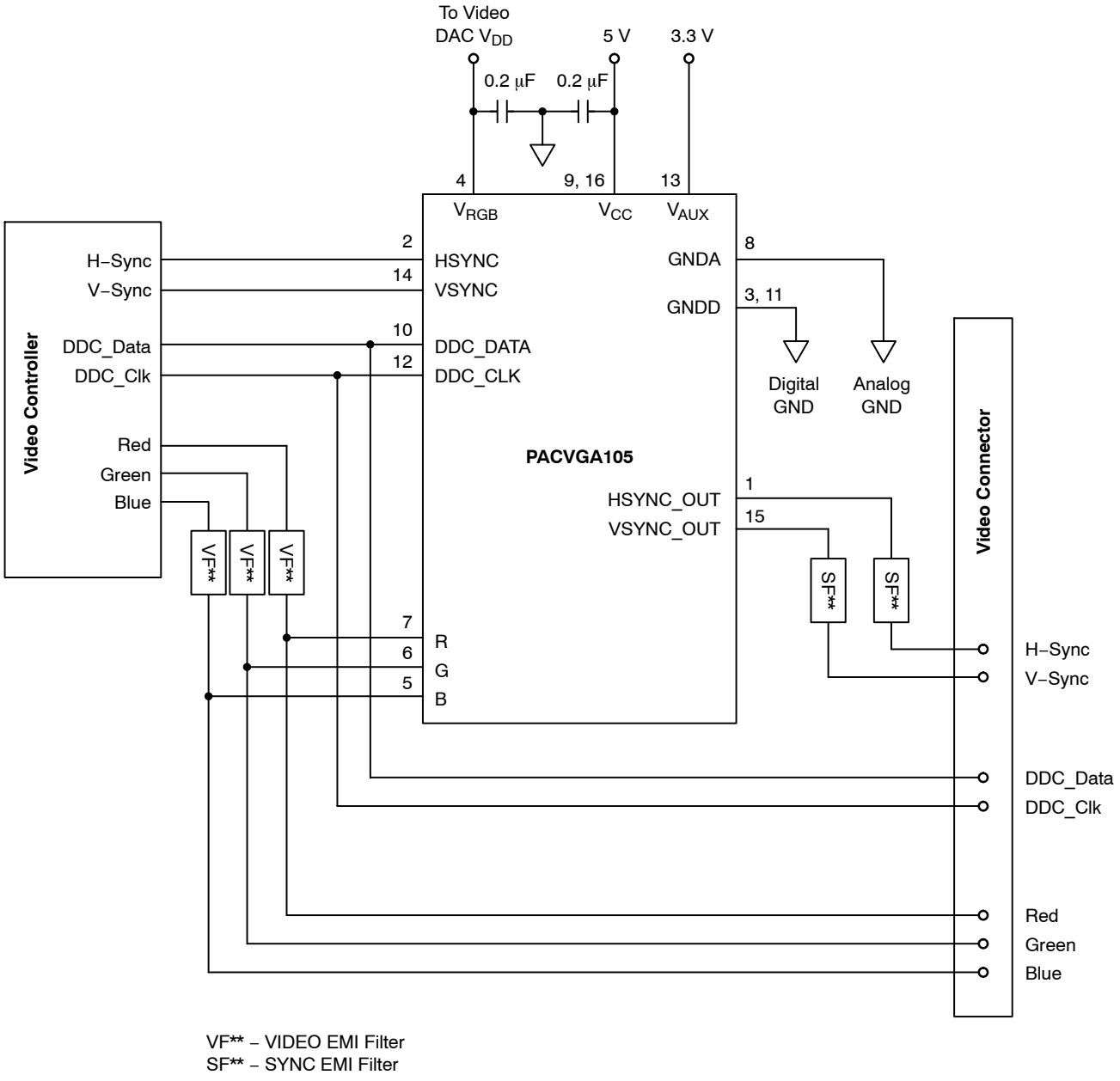


Figure 1. Typical Connection Diagram

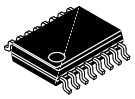
GNDA, the negative voltage rail for the R, G and B diodes is not connected internally to GNDD. GNDA should ideally be connected to the ground of the video DAC IC. This will prevent any ground bounce caused by digital signals from injecting noise onto the R, G and B signals. Analog GND and digital GND are typically connected on the printed circuit board.

MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

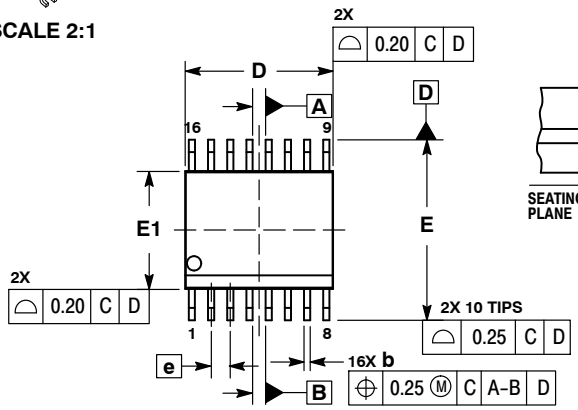
ON Semiconductor®

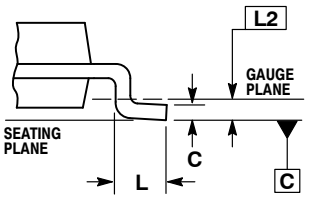
QSOP16
CASE 492−01
ISSUE A

DATE 23 MAR 2011

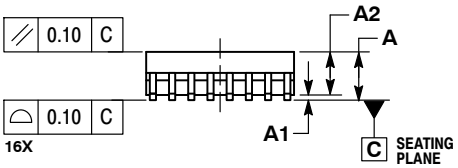


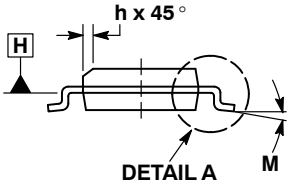
SCALE 2:1





DETAIL A

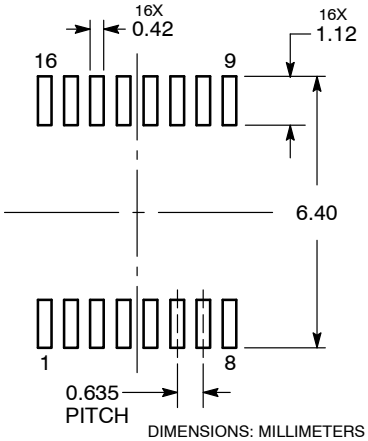




NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION.
4. DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.005 PER SIDE. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.005 PER SIDE. D AND E1 ARE DETERMINED AT DATUM H.
5. DATUMS A AND B ARE DETERMINED AT DATUM H.

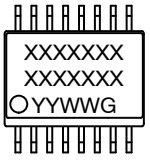
	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
A2	0.049	----	1.24	----
b	0.008	0.012	0.20	0.30
c	0.007	0.010	0.19	0.25
D	0.193 BSC		4.89 BSC	
E	0.237 BSC		6.00 BSC	
E1	0.154 BSC		3.90 BSC	
e	0.025 BSC		0.635 BSC	
h	0.009	0.020	0.22	0.50
L	0.016	0.050	0.40	1.27
L2	0.010 BSC		0.25 BSC	
M	0°	8°	0°	8°

SOLDERING FOOTPRINT



DIMENSIONS: MILLIMETERS

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code
YY = Year
WW = Work Week
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G”, may or not be present.

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